# Qualcom

RF360 Europe GmbH

## **Data sheet**

SAW diplexer Automotive telematics TD-SCDMA bands 34 & 39

Series/type:	B4384
Ordering code:	B39202B4384P810

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#### 1 Application

- Low-loss 2in1 RF filter for TD-SCDMA band 34 and TD-SCDMA band 39 systems
- TD-SCDMA B34: 15MHz
- TD-SCDMA B39: 40MHz
- Low amplitude ripple

#### 2 Features

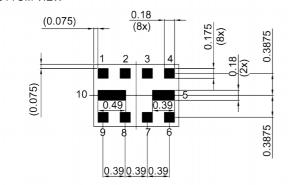
- Package size 1.5±0.1 mm × 1.1±0.1 mm
- Package height 0.45 mm (max.)
- Approximate weight 3 mg
- RoHS compatible
- Package for Surface Mount Technology (SMT)
- Ni/Au-plated terminals
- Filter surface passivated
- Electrostatic Sensitive Device (ESD)
- Moisture Sensitivity Level 2a (MSL2a)
- AEC-Q200 qualified component family (Grade 3: -40 °C to +85 °C)



Figure 1: Picture of component with example of product marking.

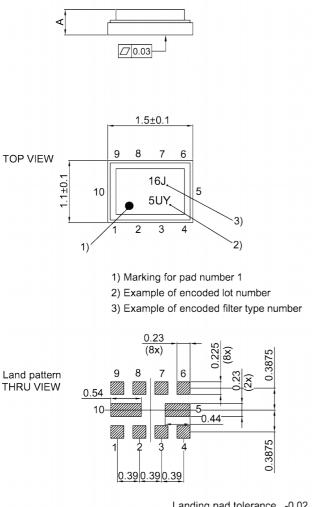
#### 3 Package

BOTTOM VIEW



Pad and pitch tolerance ±0.05

SIDE VIEW



Landing pad tolerance -0.02 **Figure 2:** Drawing of package with package height A = 0.45 mm (max.). See Sec. Package information (p. 20).

## 6 ■

4

1

■ 9 Output (B39)

**Pin configuration** 

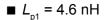
Input (B34 & B39)

Output (B34)

■ 2, 3, 4, 5, Ground 7, 8, 10



#### 5 Matching circuit



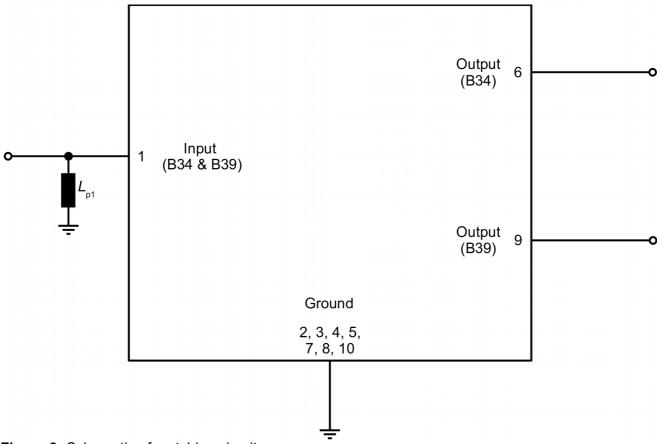


Figure 3: Schematic of matching circuit.

#### 6 Characteristics TD-SCDMA B34

Temperature range for specification	$T_{_{\rm SPEC}}$	= −30 °C +85 °C
Input terminating impedance	Z	= 50 Ω // 4.6 nH <sup>1)</sup>
B34 output terminating impedance	<b>Z</b> <sub>вз4 оит</sub>	= 50 Ω
B39 output terminating impedance	Z <sub>B39 OUT</sub>	= 50 Ω

Characteristics TD-SCDMA B34				min. for $T_{\rm SPEC}$	<b>typ.</b> @ +25 °C	max. for $T_{\rm SPEC}$	
Center frequency			f <sub>c</sub>	—	2017.5	_	MHz
Maximum insertion attenuation			$\alpha_{_{max}}$				
	2010 2025	MHz		_	1.7	2.3	dB
Amplitude ripple (p-p)			Δα				
	2010 2025	MHz		_	0.4	0.9	dB
Maximum VSWR			VSWR <sub>max</sub>				
@ input port	2010 2025	MHz		_	1.4	1.9	
@ B34 output port	2010 2025	MHz		_	1.4	1.9	
Minimum attenuation			$\alpha_{_{min}}$				
	50 1000	MHz		35	38		dB
	1000 1850	MHz		30	34		dB
	1850 1930	MHz		33	38	_	dB
	1930 1950	MHz		30	35	—	dB
	1950 1980	MHz		7	18	—	dB
	2050 2075	MHz		2.8	10	—	dB
	2075 2100	MHz		27	33	_	dB
	2100 2800	MHz		33	38	—	dB
	2800 4100	MHz		35	40	—	dB
	4100 4900	MHz		29	36	—	dB
	4900 6000	MHz		23	30	—	dB

<sup>1)</sup> See Sec. Matching circuit (p. 6).

#### 7 Characteristics TD-SCDMA B39

Temperature range for specification	$T_{_{\rm SPEC}}$	= −30 °C +85 °C
Input terminating impedance	Z	= 50 Ω // 4.6 nH <sup>1)</sup>
B34 output terminating impedance	Z <sub>B34 OUT</sub>	= 50 Ω
B39 output terminating impedance	Z <sub>B39 OUT</sub>	= 50 Ω

Characteristics TD-SCDMA B39				min. for $T_{_{ m SPEC}}$	<b>typ.</b> @ +25 °C	max. for $T_{\rm SPEC}$	
Center frequency			f <sub>c</sub>		1900	—	MHz
Maximum insertion attenuation			$\alpha_{max}$				
	1880 1920	MHz		_	1.9	2.4	dB
Amplitude ripple (p-p)			Δα				
	1880 1920	MHz		—	0.6	1.2	dB
Maximum VSWR			$VSWR_{max}$				
@ input port	1880 1920	MHz		_	1.6	2.0	
@ B39 output port	1880 1920	MHz		—	1.7	2.0	
Minimum attenuation			$\alpha_{_{min}}$				
	50 925	MHz		31	34	—	dB
	925 960	MHz		31	34	—	dB
	960 1805	MHz		25	29	—	dB
	1805 1840	MHz		27	35	_	dB
	1840 1850	MHz		26	34	_	dB
	1982 2005	MHz		28	32		dB
	2005 2800	MHz		28	33		dB
	2800 3700	MHz		32	38		dB
	3700 5400	MHz		20	27	—	dB
	5400 6000	MHz		16	24	—	dB

<sup>1)</sup> See Sec. Matching circuit (p. 6).

#### 8 Maximum ratings

Operable temperature	<i>T</i> <sub>OP</sub> = -40 °C +85 °C	
Storage temperature	$T_{\rm STG}^{1)} = -40 ^{\circ}{\rm C} \dots +85 ^{\circ}{\rm C}$	
DC voltage	$ V_{\rm DC} ^{2} = 0 V (max.)$	
Input power	P <sub>IN</sub>	
@ input port: 1880 1920 MHz	10 dBm	Continuous wave for 100000 h @ 85 °C.
@ input port: 2010 2025 MHz	10 dBm	Continuous wave for 100000 h @ 85 °C.

<sup>1)</sup> Not valid for packaging material. Storage temperature for packaging material is -25 °C to +40 °C.

<sup>2)</sup> In case of applied DC voltage blocking capacitors are mandatory.





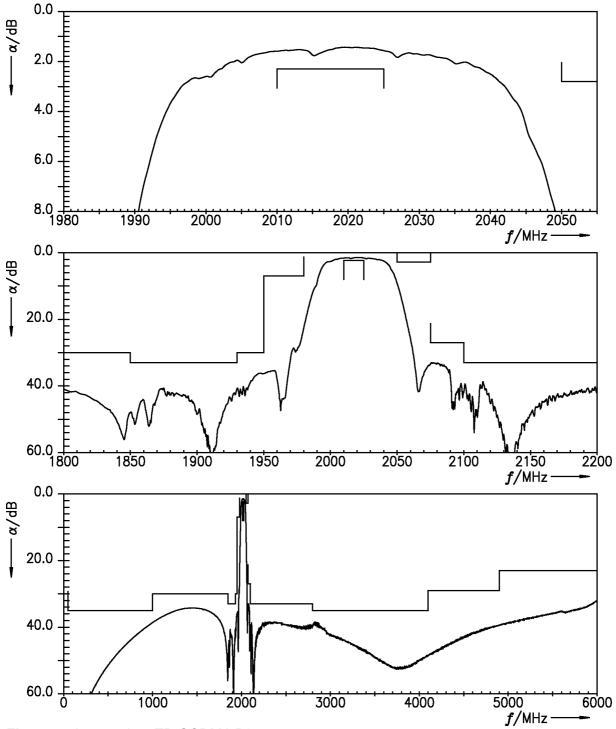
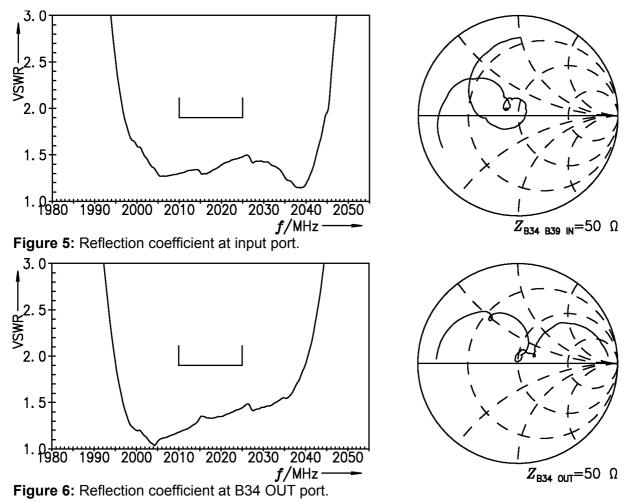


Figure 4: Attenuation TD-SCDMA B34.

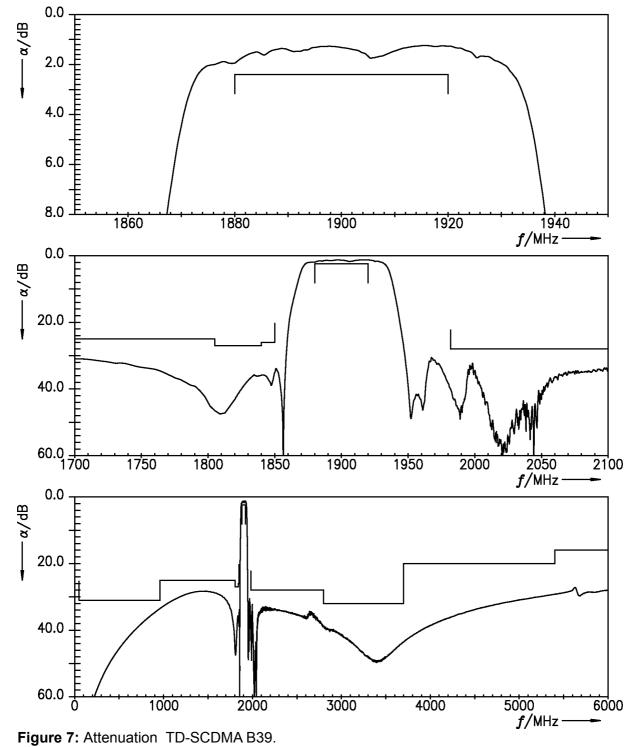


#### 10 Reflection coefficients TD-SCDMA B34



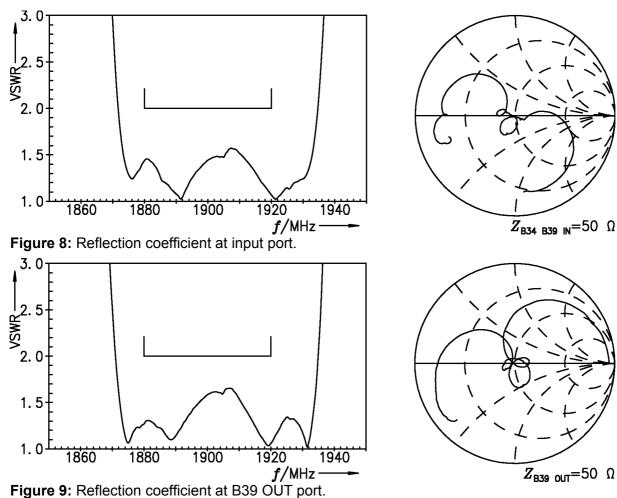


#### 11 Transmission coefficient TD-SCDMA B39





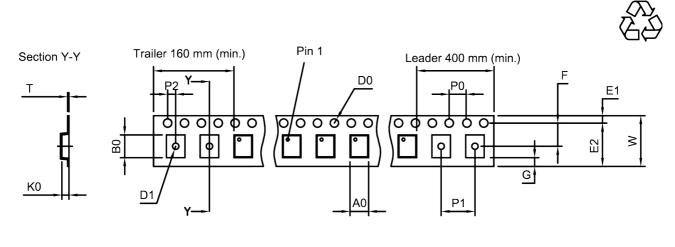
#### 12 Reflection coefficients TD-SCDMA B39





#### 13 Packing material

#### 13.1 Tape



User direction of unreeling

**Figure 10:** Drawing of tape (first-angle projection) for illustration only and not to scale. The valid tape dimensions are listed in Table 1.

 $\begin{array}{c} A_0 \\ B_0 \\ 1.27_{\pm 0.05} \text{ mm} \\ B_0 \\ 1.67_{\pm 0.05} \text{ mm} \\ D_0 \\ 1.5_{\pm 0.1/-0} \text{ mm} \\ D_1 \\ 0.5_{\pm 0.1/-0} \text{ mm} \\ E_1 \\ 1.75_{\pm 0.1} \text{ mm} \end{array}$ 

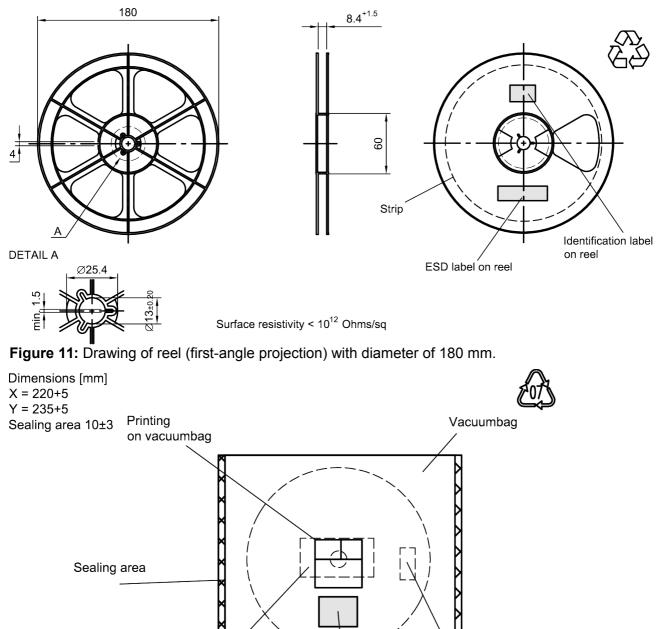
Table 1: Tape dimensions.

E2	6.25 mm (min.)
F	3.5±0.05 mm
G	0.75 mm (min.)
K <sub>0</sub>	0.55±0.05 mm
P <sub>0</sub>	4.0±0.1 mm

P <sub>1</sub>	4.0±0.1 mm
P <sub>2</sub>	2.0±0.05 mm
Т	0.25±0.03 mm
W	8.0+0.3/-0.1 mm



#### 13.2 Reel with diameter of 180 mm



Drypack

in vacuumbag

Humidity indicator

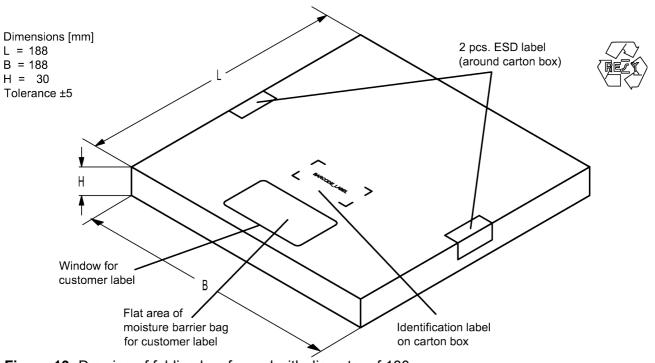
in vaccumbag

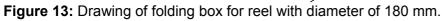
Identification label

on vacuumbag

Figure 12: Drawing of moisture barrier bag (MBB) for reel with diameter of 180 mm.

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#### 14 Marking

Products are marked with product type number and lot number encoded according to Table 2:

■ Type number:

The 4 digit type number is encoded by a special	e.g., B3xxxxB <u>1234</u> xxxx,	
	type number marking on device => 32 <sup>1</sup> + <b>18 (=J)</b> x 32 <sup>0</sup> = roduct type B4384 is 490.	in decimal code. 1234 1234

■ Lot number:

The last 5 digits of the lot number, 12345, e.g., are encoded based on a special BASE47 code into a 3 digit marking.

Example of decoding lot number marking on device 5UY

decoding lot number marking on device		in decimal code.
5UY	=>	12345
<b>5</b> x 47 <sup>2</sup> + <b>27 (=U)</b> x 47 <sup>1</sup> + <b>31 (=Y)</b> x 47 <sup>0</sup>	=	12345

Adopted BASE32 code for type number				
Decimal	Base32	Decimal	Base32	
value	code	value	code	
0	0	16	G	
1	1	17	Н	
2	2	18	J	
3	3	19	K	
4	4	20	М	
5	5	21	N	
6	6	22	Р	
7	7	23	Q	
8	8	24	R	
9	9	25	S	
10	А	26	Т	
11	В	27	V	
12	С	28	W	
13	D	29	Х	
14	E	30	Y	
15	F	31	Z	

Adopted BASE47 code for lot number			
Decimal	Base47	Decimal	Base47
value	code	value	code
0	0	24	R
1	1	25	S
2	2	26	Т
3	3	27	U
4	4	28	V
5	5	29	W
6	6	30	X
7	7	31	Y
8	8	32	Z
9	9	33	b
10	А	34	d
11	В	35	f
12	С	36	h
13	D	37	n
14	E	38	r
15	F	39	t
16	G	40	v
17	Н	41	١
18	J	42	?
19	К	43	{
20	L	44	}
21	М	45	<
22	N	46	>
23	Р		

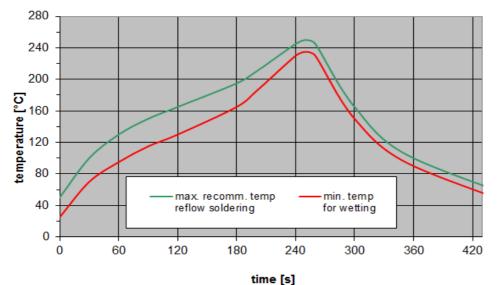
Table 2: Lists for encoding and decoding of marking.

#### 15 Soldering profile

The recommended soldering process is in accordance with IEC 60068-2-58 – 3<sup>rd</sup> edit and IPC/JEDEC J-STD-020B.

ramp rate	≤ 3 K/s	
preheat	125 °C to 220 °C, 150 s to 210 s, 0.4 K/s to 1.0 K/s	
<i>T</i> > 220 °C	30 s to 70 s	
<i>T</i> > 230 °C	min. 10 s	
<i>T</i> > 245 °C	max. 20 s	
<i>T</i> ≥ 255 °C	-	
peak temperature $T_{peak}$	250 °C +0/-5 °C	
wetting temperature $T_{min}$	230 °C +5/-0 °C for 10 s ± 1 s	
cooling rate	≤ 3 K/s	
soldering temperature T	measured at solder pads	

 Table 3: Characteristics of recommended soldering profile for lead-free solder (Sn95.5Ag3.8Cu0.7).



**Figure 14:** Recommended reflow profile for convection and infrared soldering – lead-free solder.

#### 16 Annotations

#### 16.1 RoHS compatibility

ROHS-compatible means that products are compatible with the requirements according to Art. 4 (substance restrictions) of Directive 2011/65/EU of the European Parliament and of the Council of June 8th, 2011, on the restriction of the use of certain hazardous substances in electrical and electronic equipment ("Directive") with due regard to the application of exemptions as per Annex III of the Directive in certain cases.

#### 16.2 Scattering parameters (S-parameters)

The pin/port assignment is available in the headers of the S-parameter files. Please contact your local RF360 sales office.

#### 17 Cautions and warnings

#### 17.1 Display of ordering codes for RF360 products

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#### 17.2 Material information

Due to technical requirements components may contain dangerous substances. For information on the type in question please also contact one of our sales offices.

For information on recycling of tapes and reels please contact one of our sales offices.

#### 17.3 Moldability

Before using in overmolding environment, please contact your local RF360 sales office.

#### 17.4 Package information

#### Landing area

The printed circuit board (PCB) land pattern (landing area) shown is based on RF360 internal development and empirical data and illustrated for example purposes, only. As customers' SMD assembly processes may have a plenty of variants and influence factors which are not under control or knowledge of RF360, additional careful process development on customer side is necessary and strongly recommended in order to achieve best soldering results tailored to the particular customer needs.

#### Dimensions

Unless otherwise specified all dimensions are understood using unit millimeter (mm).

Dimensions do not include burrs.

#### **Projection method**

Unless otherwise specified first-angle projection is applied.



#### 18 Important notes

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